

R1



R2



+

R1



MT1



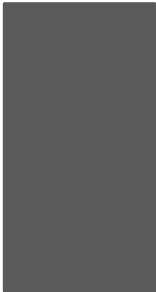
C1



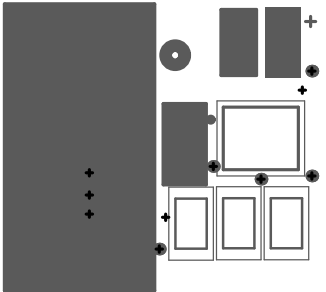
C2



C3









Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Overlay		0mil	
2		Top Solder	Solder Resist	0.4mil	3.5
3		Top Layer		1.4mil	
4		Dielectric 1	FR-4	12.6mil	4.8
5		Bottom Layer		1.4mil	
6		Bottom Solder	Solder Resist	0.4mil	3.5
7		Bottom Overlay		0mil	
	Height : 16.2mil				